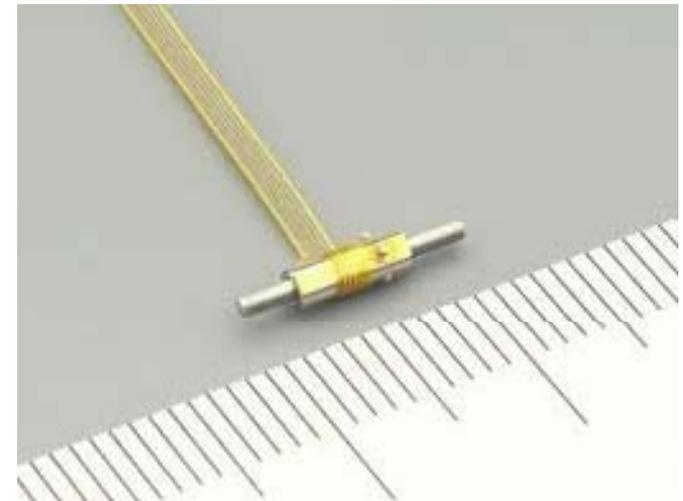
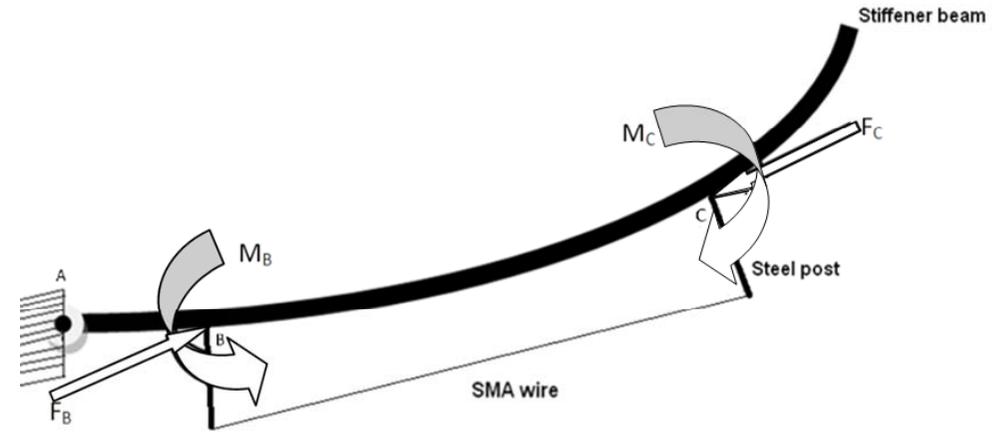


APA230L, APA150M, APA100S

Module 5: Actuators & Sensors based on HBLS Smart Materials

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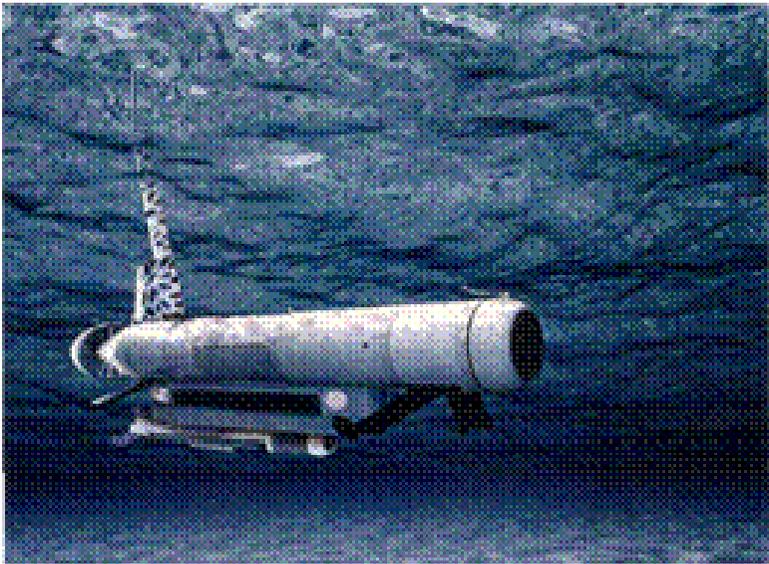
LECTURE 36

Delamination Sensing and Vibration Control using Magnetostrictive Materials (Part 2)

Organization of this Lecture

- Symmetric Laminate with Magnetostrictive Sensor
- Asymmetric Laminate with Magnetostrictive Sensor
- Sensing Delamination: Results of Numerical Analysis

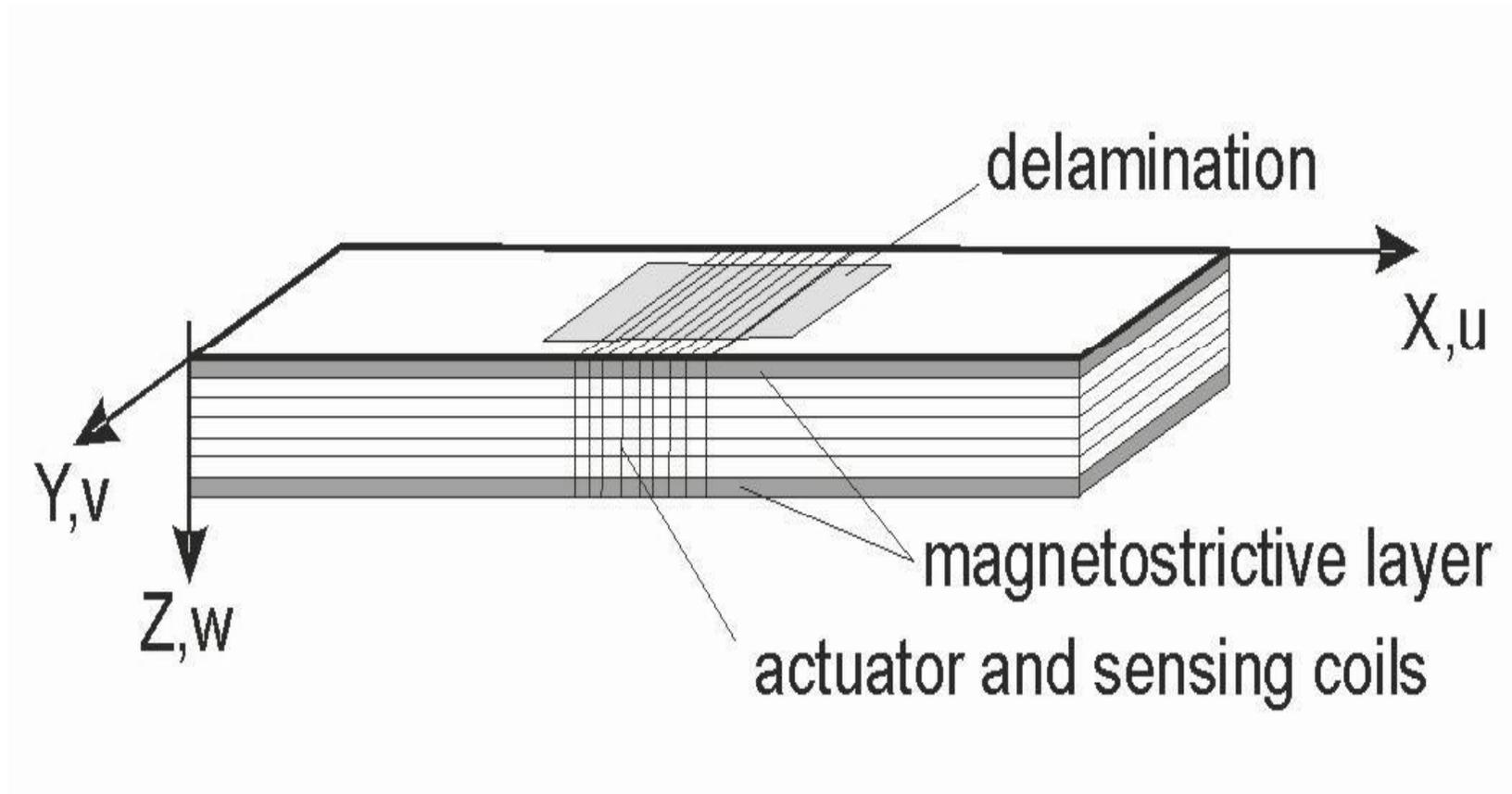
Magnetostrictive Material: High Bandwidth- Moderate Strain Actuation



- **DC to 3 KHz Bandwidth**
- **Force availability reported up to 1700 N**
- **Free Strain: 3000 micron**

TALON (Tactical Acoustic Littoral Ocean Network) sonar system uses Magnetostrictive Terfenol-D for under-water submarine detection, source: Etrema Products

Smart laminate beam



Symmetric/Asymmetric laminate

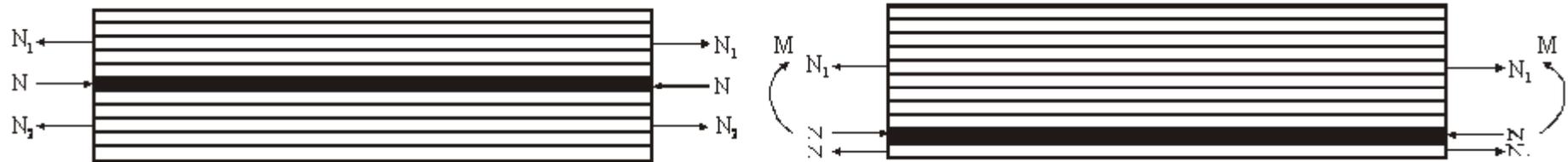


Fig 1 (a) Forces on the symmetric beam (b) Moment on asymmetric beam due to stresses induced in the magnetostrictive layer

Net Force in magnetostrictive layer (Compressive) $N = \sigma h_m$

Forces in upper & lower segment $N_1 = A_1 \varepsilon$ & $N_2 = A_2 \varepsilon$

If no external force is applied

$$N = N_1 + N_2$$

$$\text{Strain } \varepsilon = N / (A_1 + A_2)$$

$$\text{Stress } \sigma = \alpha I$$

$$\alpha = \frac{dN}{\left[\frac{h_m}{A_1 + A_2} - S^H \right]}$$

Asymmetric composite laminate (...contd..)

Moment on the beam due to stresses induced in the magnetostrictive layer

$$M = N_1 a + N_2 c - N b$$

Mid plane curvature

$$\lambda = \frac{M - B\varepsilon}{D}$$

Axial strain/stress in magnetostrictive layer including the effect of bending

$$\varepsilon' = \varepsilon - z_k \lambda$$

$$\sigma' = \frac{1}{S} [\varepsilon' - dnI_0 \sin \omega t]$$

Failure criterion (Griffith's)

Delamination will be initiated when stress intensity factor

K_I

exceeds critical stress intensity factor

K_{IC}

$$K_I \geq \beta \cdot K_{IC}$$

$$K_I = \sigma \sqrt{\pi \cdot C}$$

Failure criterion (Tsai-Wu)

$$F_1\sigma_1 + F_{11}\sigma_1^2 + F_2\sigma_2 + F_{22}\sigma_2^2 + 2F_{12}\sigma_1\sigma_2 + F_{66}\tau_{12}^2 = 1$$

$$F_1 = 1/X_\tau + 1/X_\varsigma \quad F_{11} = -1/X_\tau X_\varsigma$$

$$F_2 = 1/Y_\tau + 1/Y_\varsigma \quad F_{22} = 1/Y_\tau Y_\varsigma$$

$$F_{66} = 1/S^2$$

Voltage analysis

Symmetric laminate $B = (d\alpha + \mu N) I$
 $V = -nla_r (d\alpha + \mu N) I_0 \omega \cos \omega t$

Asymmetric laminate
without mechanical loading $V' = -nla_r (d\alpha' + \mu N) I_0 \omega \cos \omega t$
with mechanical loading

$$V'' = -nla_r \left[d \left[\bar{Q} \right] (\varepsilon_0' + z_k \lambda') + \mu n I_0 \right] \omega \cos \omega t$$

Table 1: Numerical details used in analysis

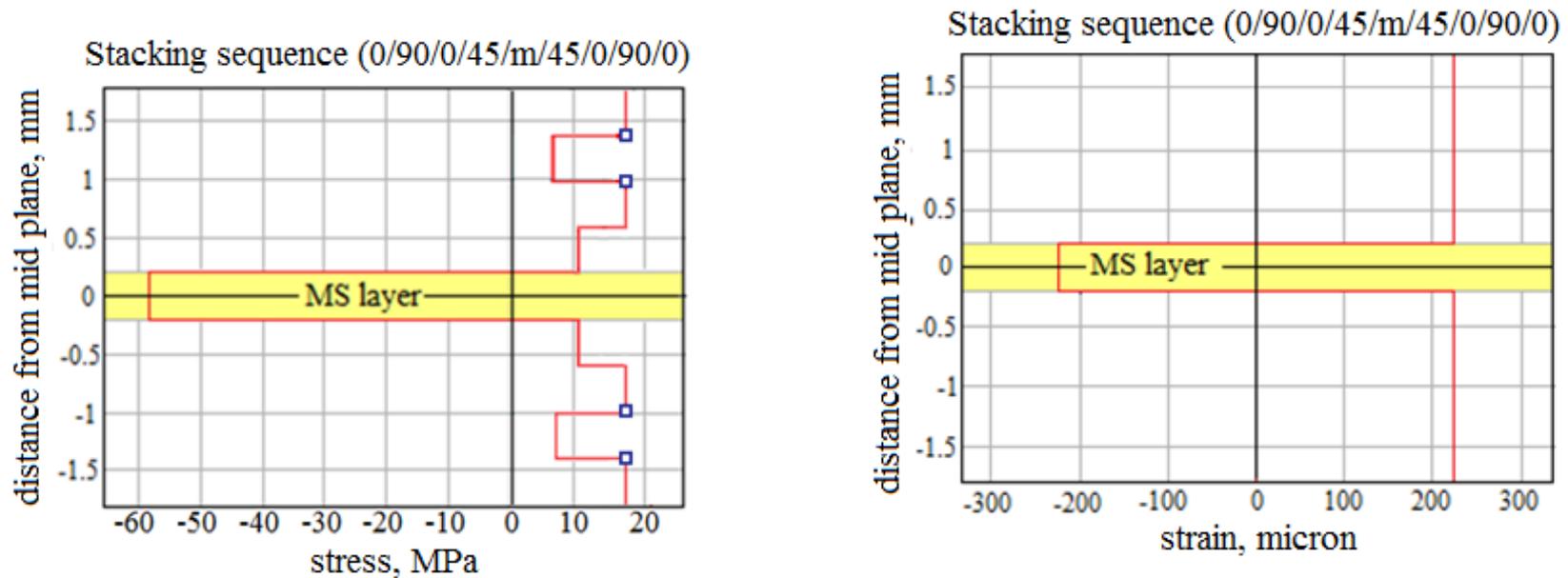
Number of plies including MS layer	9
Symmetric laminate stacking	[0/90/0/45/m/45/0/90/0]
Asymmetric laminate stacking	[0/90/0/45/0/90/m/90/0]
Composite used	carbon - epoxy
Elastic modulus of carbon fibers	350 GPa
Elastic modulus of epoxy matrix	3.50 GPa
Elastic modulus of Terfenol- D	30 GPa
Volume fraction of fiber	0.16
Volume fraction of Terfenol-D	0.0224
Poisson's ratio of carbon fiber	0.3
Poisson's ratio of epoxy matrix	0.4
Poisson's ratio for Terfenol-D	0.25

Table 1: Numerical details (...Contd.)

• Number of turns in the coil per meter length of beam	1000
• Carrier frequency	1000Hz
• Carrier current	0.4 A
• Piezomagnetic coefficient	$1.5 \times 10^{-8} \text{ m/A}$
• Permeability	14.13×10^{-7}
• Coupling coefficient of Terfenol-D	0.75
• Tensile strength of Terfenol-D	28 MPa
• Compressive strength of Terfenol-D	700 MPa
• Fracture toughness of MS layer	$30 \text{ MPa}\cdot\text{m}^{1/2}$
• Size of crack at delamination	2 mm
• Length of beam	100 mm
• Width of over all beam structure	20 mm
• Thickness of composite lamina	0.4 mm
• Thickness of MS layer	0.4 mm

Results of analysis

Stress and strain variations at various interfaces and in MS layer (actuator current only)

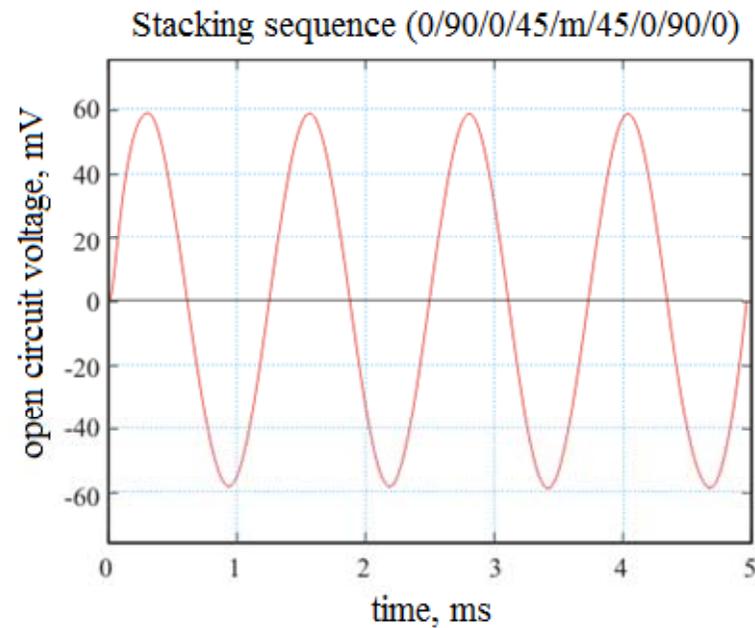


Symmetric laminate

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November 17-19, 2010

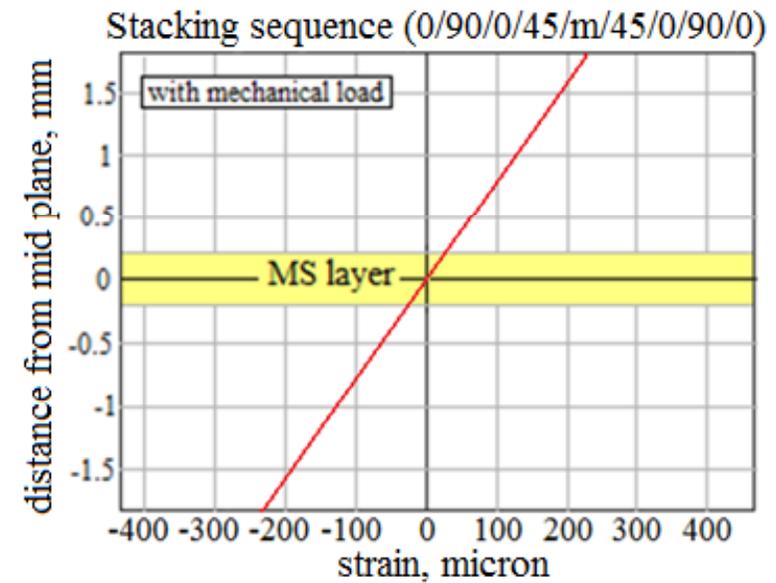
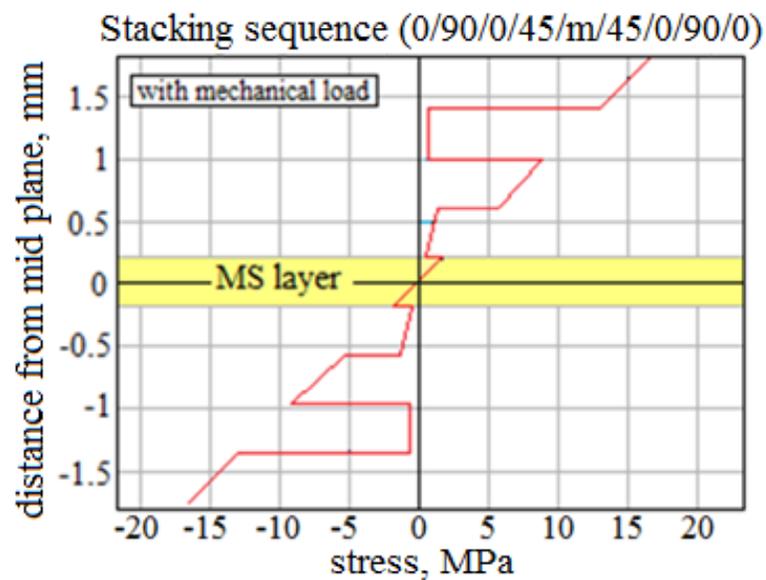
Open circuit voltage in MS layer at the time of delamination (actuator current only)



Symmetric laminate

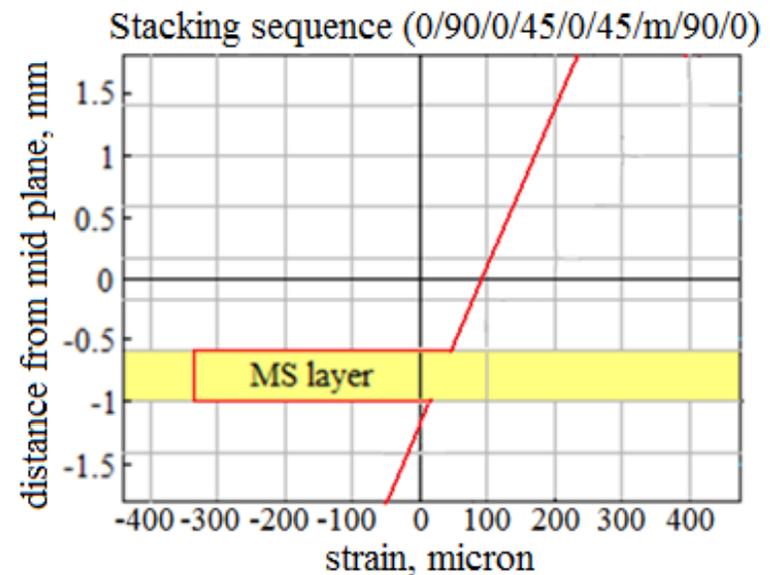
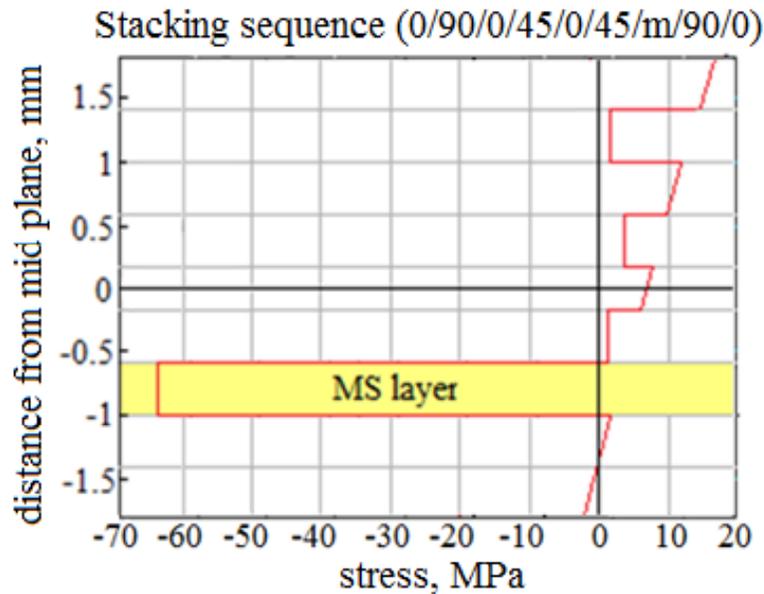
Results...

Stress and Strain variations at various interfaces and in MS layer (mechanical load along with actuator current)



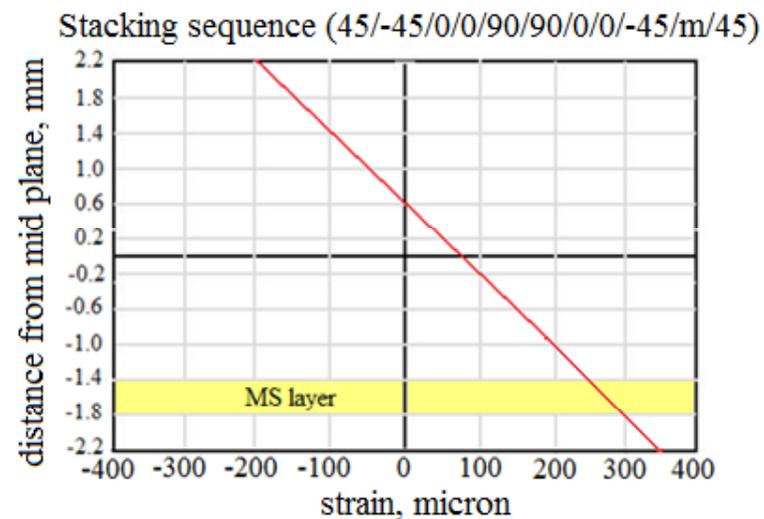
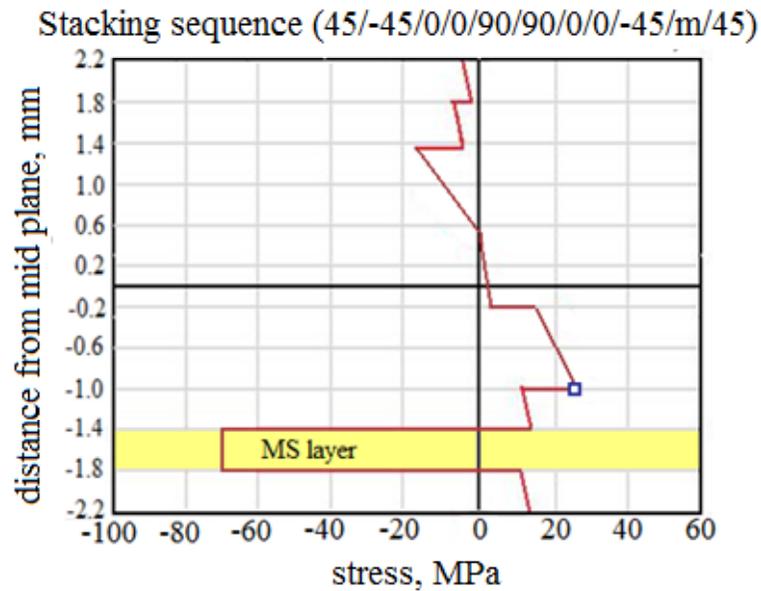
Symmetric laminate

Stress and Strain variations at various interfaces and in MS layer (mechanical load along with actuator current)



Asymmetric laminate

Stress and Strain variations at various interfaces and in MS layer (actuator current only)

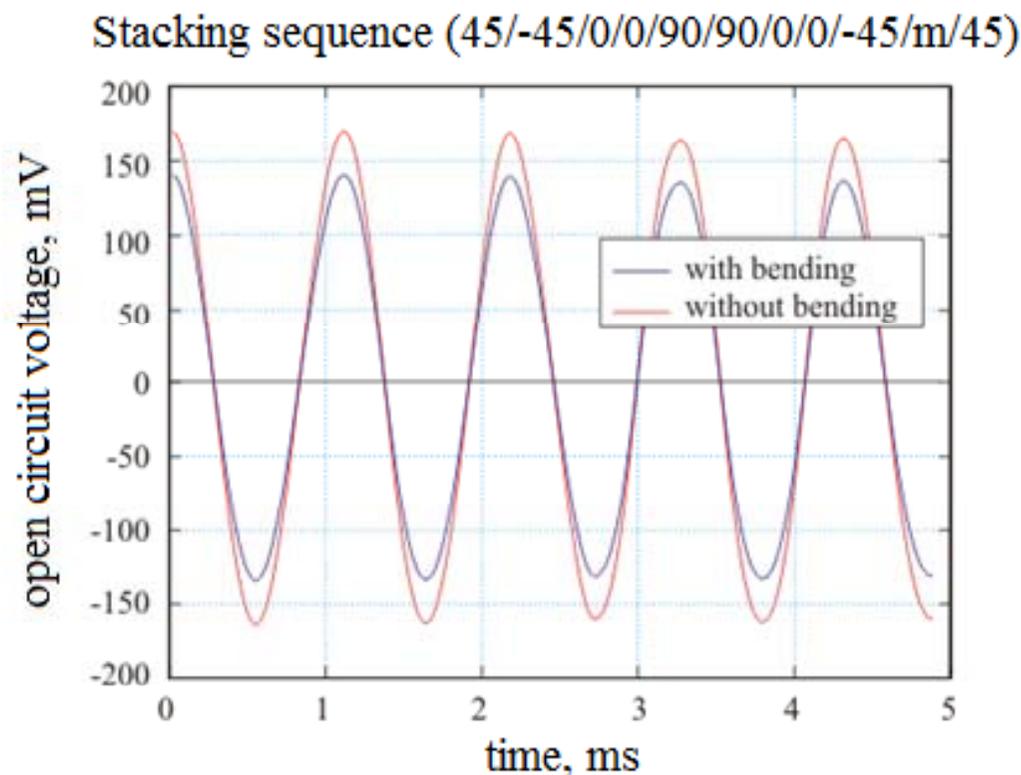


Asymmetric laminate

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Open circuit voltage in MS layer at the time of delamination

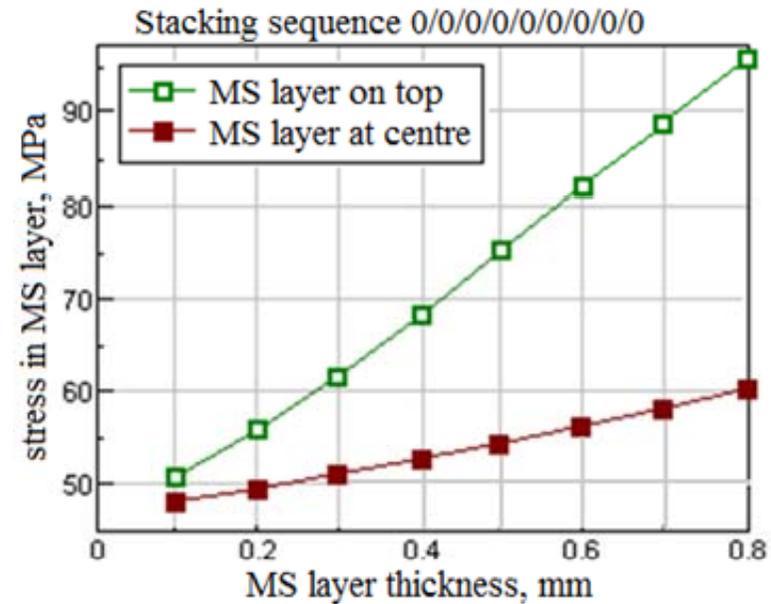
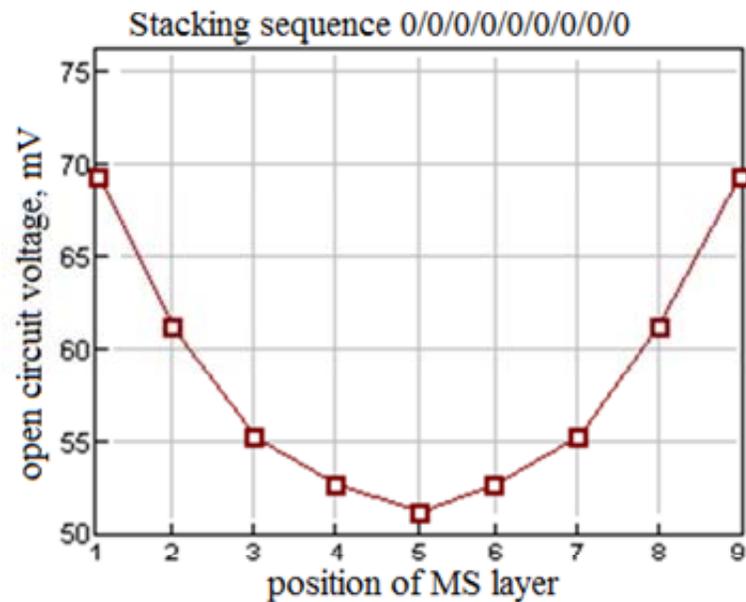


with and without bending consideration

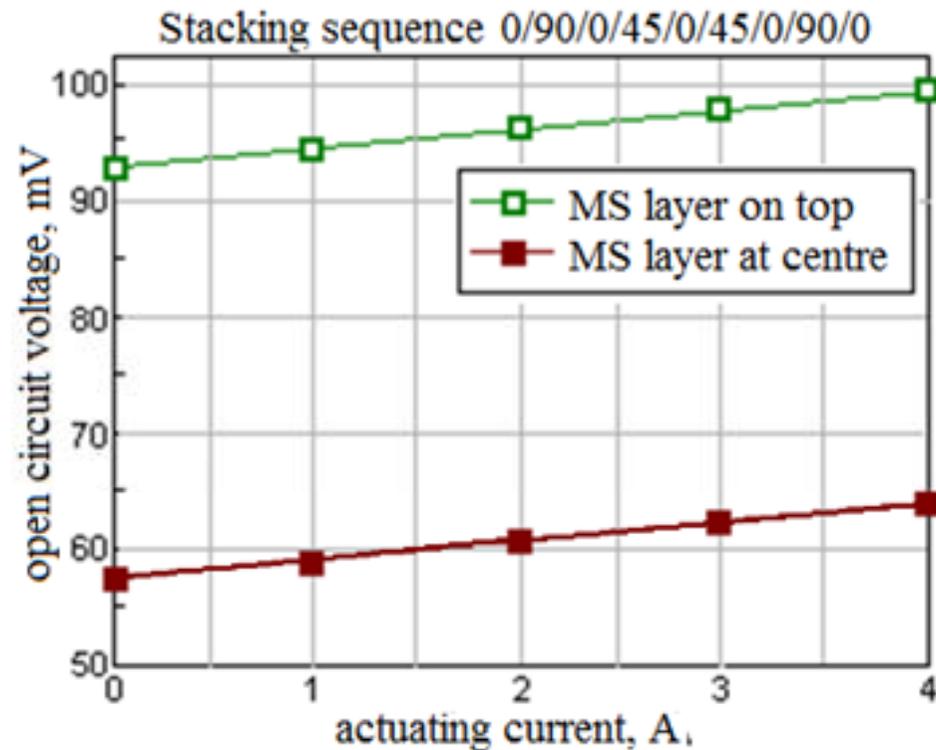
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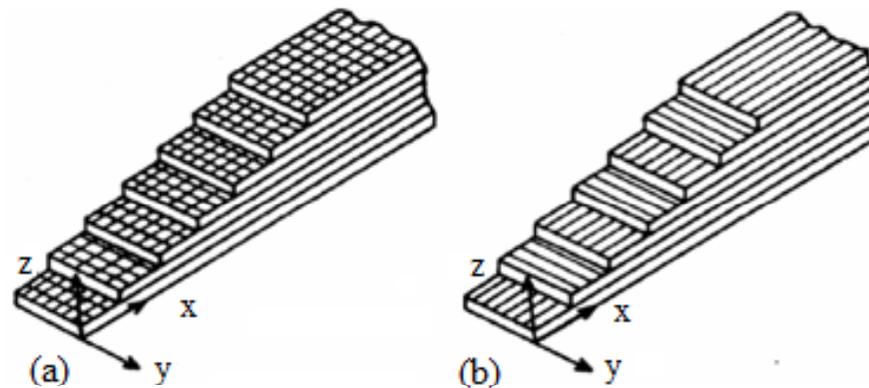
Effect of position of MS layer and its thickness



Open circuit voltage in the sensing coil with the increase in current in actuating coil.

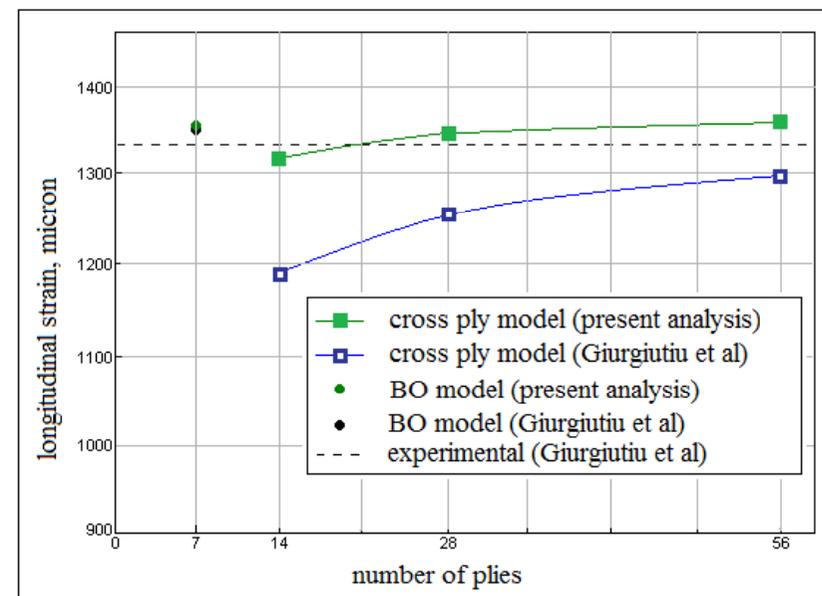
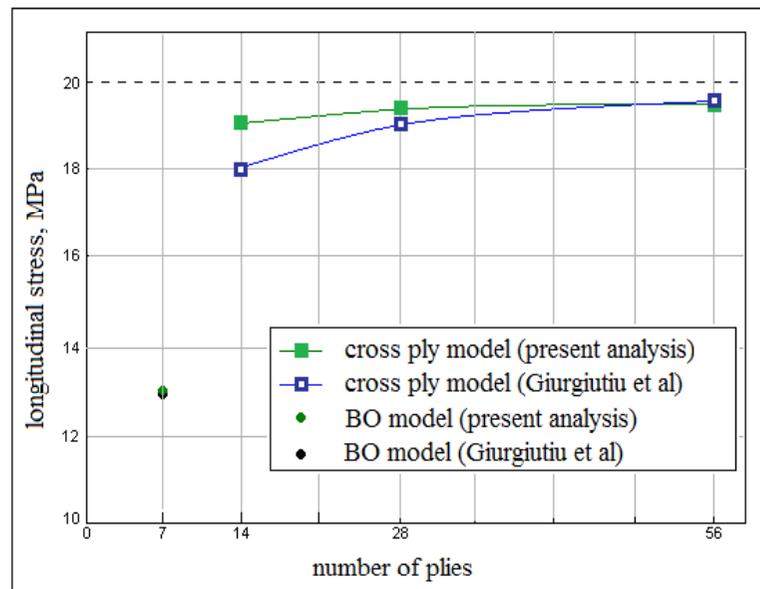


Validation of present model for woven composite



(a) Balanced orthotropic and (b) Orthotropic cross ply layup models.

Convergence of longitudinal stress and strain results on the beam surface under maximum load condition as predicted by various models



Major observations

- Variation of stress in delaminating interface and MS layer induces voltage in MS layer.
- Under axial loading, MS layer is subjected to compressive stresses while the remaining layers are under tension.
- In symmetrical laminates more than one interface can delaminate.
- MS layer thickness and location of the layer has a bearing on sensing voltage
- Effect of orientation of laminae is more prominent than bending effect.

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